

LIGHTING PHOTOELECTRIC TECHNOLOGY CO., LTD

C	Customer Approved				
Date:					

Part No.: LB110GHC-C01C3

DATA SHEET

Issue Date: 2017.06.14 Issue No.: LTD-110-002 REVISION: V2

Designer	Checker	Approver
Lisa	Rock	Allen

LIGHTING PHOTOELECTRIC TECHNOLOGY CO., LTD

Issue Date: 14.Jun.2017

Page: <u>1</u> / 10

Add: 288 Xing Ming Street, Suzhou Industrial District

Web: www.lighting-china.net

Tel: 0512-67302536



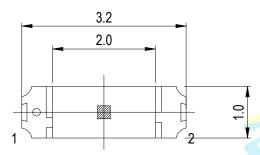
SMD Type • Side view 1204 Package LB110GHC-C01C3

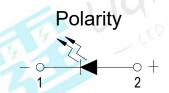
Features

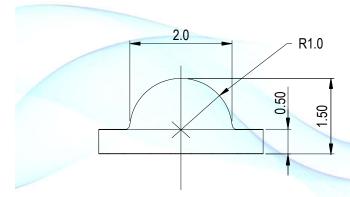
- ■1204 package
- ■Side view LED
- ■Compatible with infrared and vapor phase reflow solder process
- ■Pb-free
- ■RoHS compliant



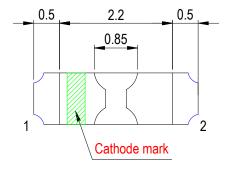
Package Dimensions

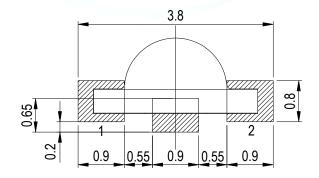






Recommended Solder Pad





Note:

Tolerance unless mentioned is ± 0.1 mm, Unit = mm.



Applications

- ■Indoor signage display applications
- ■Indoor decorating and design
- ■Signal and Symbol Luminary
- ■Automotive Telecommunication
- ■Switch lights

Device Selection Guide

Emitted Color	Resin Color
Green	Water Clear

Absolute Maximum Ratings (T_{Soldering}=25°C)

Parameter	Symbol	Rating	Unit
Forward Current	I _F	25	mA
Peak Forward Current (Duty 1/10 @1ms)	I _{FP}	60	mA
Power Dissipation	P _d 95		mW
Operating Temperature	T _{opr}	-40 ~ +85	°C
Storage Temperature	T _{stg}	-40 ~ +100	°C
Soldering Temperature	T _{sol}	Reflow Soldering : 260°C for 10 sec. Hand Soldering : 350°C for 3 sec.	
Reverse Voltage	V_R	V _R 5	

Note:

The products are sensitive to static electricity and must be carefully taken when handling products.

Electro-Optical Characteristics (T_{Soldering}=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	I_V	130	-	300	mcd	I _F =5mA
Dominant Wavelength	λ_{D}	520	-	535	nm	I _F =5mA
Forward Voltage	V_{F}	2.5	-	3.1	V	I _F =5mA
Viewing Angle	2θ _{1/2}	-	120	-	deg	I _F =5mA
Reverse Current	I _R	-	-	1	μΑ	V _R =5V

Notes:

- 1. Tolerance of Luminous Intensity ±10%.
- 2. Tolerance of Dominant Wavelength: ±1nm.
- 3. Tolerance of Forward Voltage: ±0.05V.



Bin Code Description

Bin Range of Luminous Intensity

Bin Code	Min.	Max.	Unit	Condition
o1	130	160		
o2	160	200	mcd	I
p1	200	250		I _F =5mA
p2	250	300		

Bin Range of Dominant Wavelength

Bin Code	Min.	Max.	Unit	Condition
A5	520	525	. 1	711
A6	525	530	_ nm	I _F =5mA
A7	530	535		19/20

Bin Range of Forward Voltage

Bill Range of Forward Voltage					
	Bin Code	Min.	Max.	Unit	Condition
	32	2.5	2.6		
	33	2.6	2.7		
	34	2.7	2.8	V	I 5 A
	35	2.8	2.9	V	I _F =5mA
	36	2.9	3.0		
	37	3.0	3.1	1	

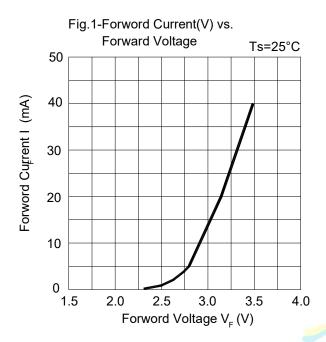
Notes:

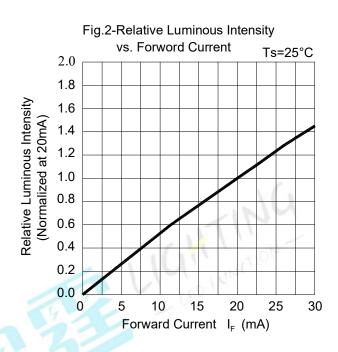
- 1. Tolerance of Luminous Intensity ±10%.
- 2. Tolerance of Dominant Wavelength: ±1nm.
- 3. Tolerance of Forward Voltage: ±0.05V.

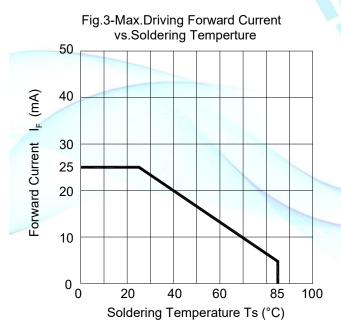
Page: 4 / 10

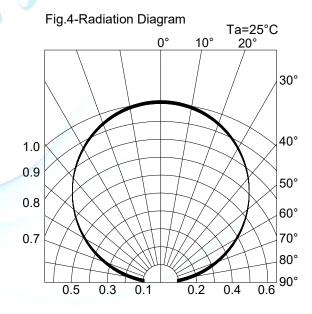


Typical Electro-Optical Characteristics Curves







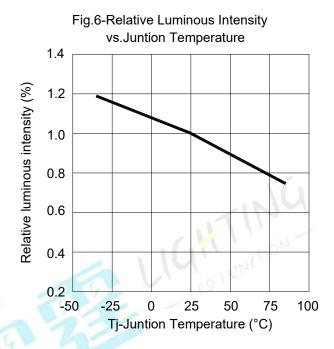


Page: 5 / 10

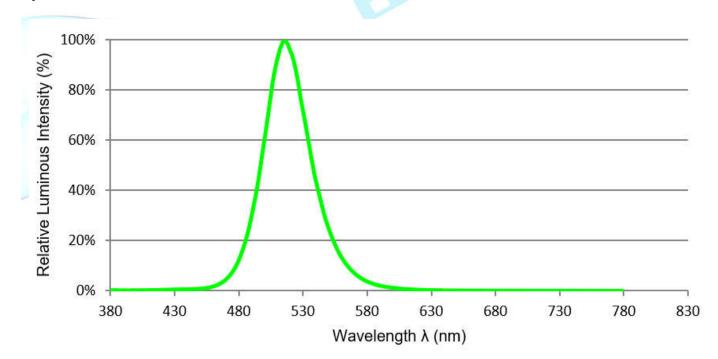


Typical Electro-Optical Characteristics Curves

Fig.5-Forword Voltage Shift vs. Juntion Temperature 0.20 0.15 Forword Voltage Shift -V 0.10 0.05 0.00 -0.05 -0.10 -0.15 -0.20 100 -50 -25 0 25 50 75 Tj-Juntion Temperature (°C)



Spectrum Distribution



Issue Date: 14.Jun.2017 Issue No: V2 Issue No: LTD-110-002 www.Lighting-china.net

Page: 6 / 10



Moisture Resistant Packing Materials Label Explanation



- QR code:
 Contains all of the following information
- * P/N: Product Number
- * TYPE :Part NO.
- * IV: Luminous Intensity Rank
- * WD: Dom. Wavelength Rank
- * VF: Forward Voltage Rank
- * QTY: Packing Quantity
- * LOT NO.: Lot Number

Taping method: Loaded Quantity 3,000 pcs Per Reel



Direction of unreeling

Notes:

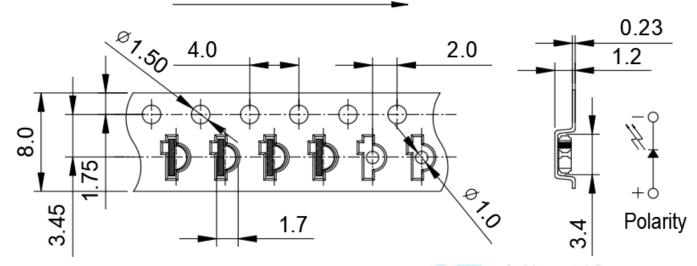
- 1.Tolerance unless mentioned is ±0.1mm,Unit = mm.
- 2. Minimum packing amount is 1000 pcs per reel.

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Carrier Tape Dimensions:

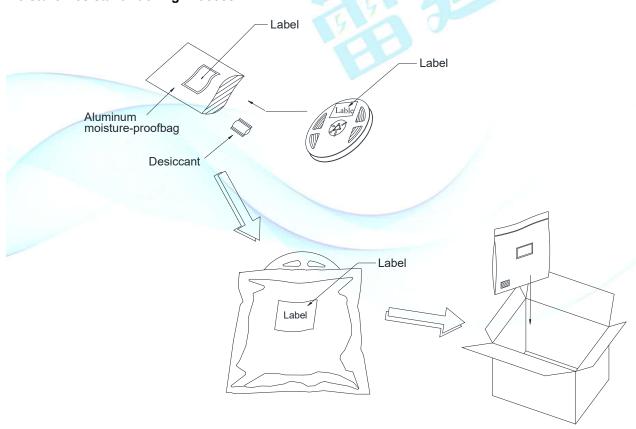
Progressive direction



Note:

Tolerance unless mentioned is ±0.1mm,Unit = mm.

Moisture Resistant Packing Process



Moisture/Reflow sensitivity classification

IPC / JEDEC J-STD-020C: Level 2

Issue Date: 14.Jun.2017

Issue No: LTD-110-002

Issue No: V2



Reliability Test Items and Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp.: 260°C/10sec.	6 Min.	22 PCS.	0/1
2	Thermal Shock	H : +100°C/5min ∫ 10 sec L : -10°C/5min	300 Cycles	22 PCS.	0/1
3	Temperature Cycle	H : +100°C/15min ∫ 5 min L : -40°C/15min	300 Cycles	2 <mark>2</mark> PCS.	0/1
4	High Temperature/Humidity Storage	Ta=85°C,85%RH	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Ta=- <mark>40°C</mark>	1000 Hrs.	22 PCS.	0/1
6	High Temperature Storage	Ta=100°C	1000 Hrs.	22 PCS.	0/1
7	DC Operation Life	Ta=25°C, I _F = 5 mA	1000 Hrs.	22 PCS.	0/1

Issue Date: 14.Jun.2017 Issue No: V2 Issue No: LTD-110-002 www.lighting-china.net

Page: 9 / 10



Precautions for Use

1. Over-current-proof

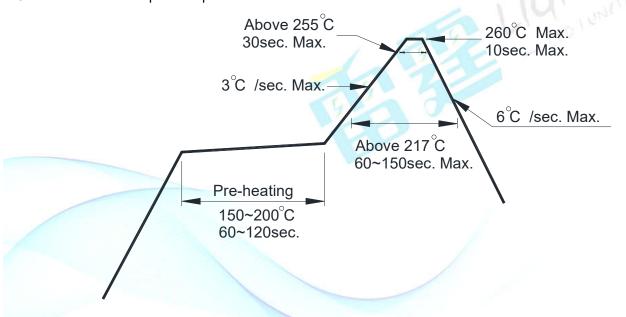
Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30°C or less and 60%RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.
 Baking treatment: 60±5°C for 24 hours.

3. Soldering Condition

3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.